Document Number: SMAV2060-30C9 Preliminary Datasheet V2.0

2.0-6.0GHz, 30W, 50V GaN Fully matched PA Module

Description

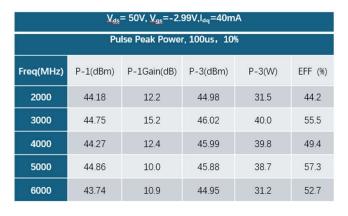
The SMAV2060-30C9 is a 30-watt, single stage integrated Power Amplifier Module, designed for broad band applications, with frequencies from 2 to 6GHz. The module is 50 Ω input/output matched and requires minimal external components.

The module implements wideband power amplifier in form of multi chips, housed in cost effective plastic open cavity package, offers a much lower cost than traditional MMIC solutions.

Please notice that

For CW, it is strongly recommended to solder device onto the heatsink directly

For Pulse, it is acceptable to solder device through high density metalized grounding vias



V_{ds} = 50V, V_{qs} =-2.99V, I_{dq} =40mA					
	CW Power				
Freq(MHz)	P-1(dBm)	P-1Gain(dB)	P-3(dBm)	P-3(W)	EFF (%)
2000	43.48	11.7	44.72	30.1	44.0
3000	43.85	14.5	45.63	36.6	53.2
4000	42.83	11.7	45.32	34.0	46.1
5000	43.56	9.8	45.37	34.5	53.1
6000	42.56	10.7	44.44	29.0	48.8

Product Features

• Operating Frequency Range: 2-6GHz

• Operating Drain Voltage: +50 V

- 50 Ω Input/Output
- Psat≥30W (Pulse)
- Small signal gain:>12dB, Power gain:>8dB
- Minimum efficiency:>40%
- 12x10 mm Surface Mount Package
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

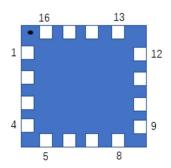
Applications

- Ultra Broadband Amplifiers
- Fiber Drivers
- Test Instrumentation
- EMC Amplifier Drivers
- 2-way Radios

Innogration (Suzhou) Co., Ltd.

Document Number: SMAV2060-30C9 Preliminary Datasheet V2.0

Pin Configuration and Description (Top view)



Pin No.	Symbol	Description
4	RF IN	RF Input
9	RF OUT	RF Output
6	Vgs	Gate bias
7	Vdd	Drain bias
Others	NC	No connection
		DC/RF Ground. Proposed to be soldered to heatsink plane directly for the best CW thermal
Package Base	GND	and RF performance. Soldered through high density vias or copper coin also allowed ,but
		will result in excessive junction temperatures and different RF performance

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
DrainSource Voltage	V _{DSS}	200	Vdc
GateSource Voltage	V _{GS}	-10 to +2	Vdc
Operating Voltage	V _{DD}	+55	Vdc
Storage Temperature Range	Tstg	-65 to +150	°C
Case Operating Temperature	T _c	+150	°C
Operating Junction Temperature	TJ	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	Paus	2	°C/W
T _C = 85°C, DC test, soldered on heatsink directly	Rejc	3	

Table 3. Electrical Characteristics

Parameter	Condition	Min	Тур	Max	Unit
Frequency Range		2000		6000	MHz
Power Gain @ Psat		10			dB
P _{SAT}	Pulse		45		dBm
Drain Efficiency @ P _{SAT}		40			%
Unless otherwise noted: TA = 25°C, V _{DD} =50 V, Pulse Width=50 us, Duty cycle=20%					

Load Mismatch of per Section (On Test Fixture, 50 ohm system): V_{DD} =50V, I_{DQ} =40 mA, f = 3.5 GHz

VSWR 10:1 at Psat pulse CW Output Power	No Device Degradation
---	-----------------------

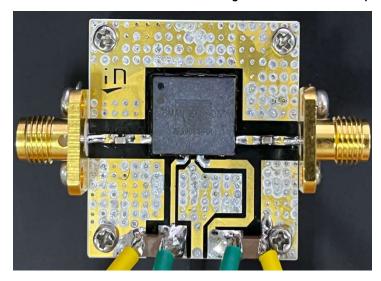


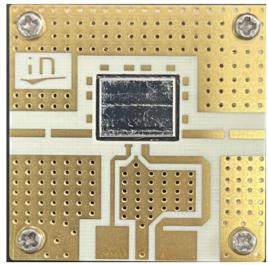
Innogration (Suzhou) Co., Ltd.

Document Number: SMAV2060-30C9 Preliminary Datasheet V2.0

Reference Circuit of Test Fixture Assembly Diagram

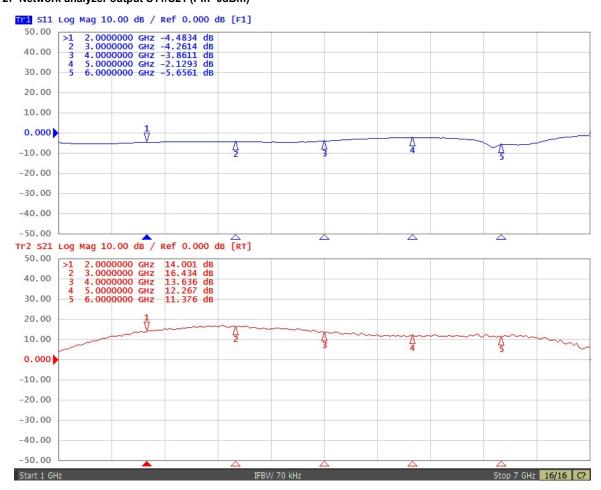
Figure 1. Test Circuit Component Layout





TYPICAL CHARACTERISTICS

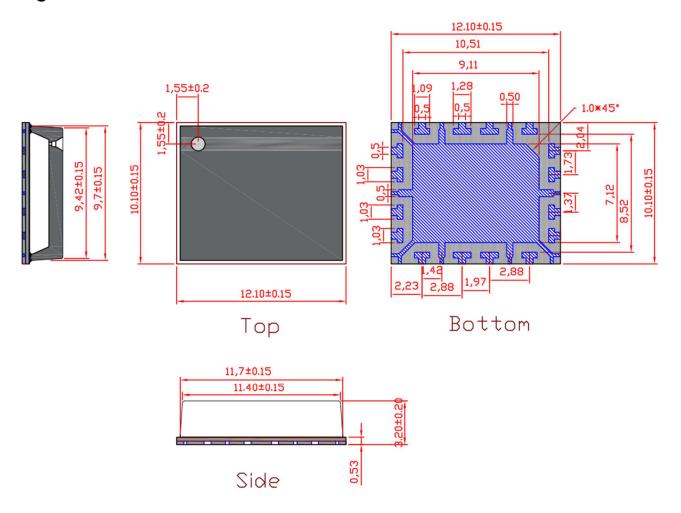
Figure 2. Network analyzer output S11/S21 (Pin=0dBm)



Innogration (Suzhou) Co., Ltd.

Document Number: SMAV2060-30C9 Preliminary Datasheet V2.0

Package Dimensions (Unit:mm)



Revision history

Table 6. Document revision history

Date	Revision	Datasheet Status
2023/2/14	Rev 1.0	Preliminary Datasheet
2024/8/21	Rev 2.0	Update to be CW capable by soldering device onto heatsink

Application data based on HJ-23-01

Disclaimers

Specifications are subject to change without notice. Innogration believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogration for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogration . Innogration makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogration in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogration products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogration product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogration and authorized distributors Copyright © by Innogration (Suzhou) Co.,Ltd.